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DESCRIPTION

The LX2202 Linear Battery Charger is a multi-state (2 stage) Li-Ion battery charger (Constant current / Constant voltage) that is designed to minimize battery charge time (even from current limited sources such as USB) and provide a simplified interface to control battery discharge.

LX2202 features up to 2A charging current from an AC adapter and an isolated battery topology to minimize charge time from current limited sources such as USB. A thermal control loop maintains a safe operating temperature at all times.

The LX2202 provides a seamless complete battery interface. When the input power source is removed, the LX2202 provides the discharge path for the battery with extremely low discharge impedance. This eliminates the need for external discharge switch and voltage supervisors.

In USB mode, the LX2202 provides three levels of current limit: 100mA, 500mA, and off.

The LX2202 (compared to the LX2201) has improved charge and discharge mode detection circuitry. A UVLO feature prevents battery charging when VDD is less than 3.6V.

The LX2202 uses three resistors to program the constant charge current level, for setting the termination charge current, and for varying the USB charge current limits. LX2202 support two types of Li-Ion battery chemistry; 4.1V and 4.2V through logical input (VM pin). The LX2202 provides a charging status indicator.

The LX2202 features a pre-charge conditioning mode for batteries that have been deeply discharged and also has a top off charge mode for batteries that are left on the charger for extended periods.

The LX2202 is available in a high power 4mm x 4mm, 20-pin MLP, surface mount package.

KEY FEATURES

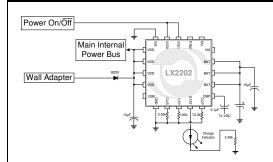
- Up to 2A Charge Current
- Internal Pass Element Can Function as a Reverse Direction Load Switch
- USB Compliant Charging States using optional USB input
 - Isolated Battery Topology
- Low Rds_{ON} in Discharge Mode
- Full Capacity Charging
- True Charge Indicator
- Wall Supply Regulator Tolerance 5V + 10%
- Topping Charge with Voltage Monitoring Mode
- Improved charge/discharge mode detection circuitry
- Small, High Power 20-lead MLP package
- Selectable Li-lon Battery for 4.1V or 4.2V Applications

APPLICATIONS

- Batteries up to 4AH Ratings (C/2)
- Cell Phones
- PDAs
- Charging Cradles
- Digital Cameras
- Low Cost Single Li-Ion Cell Chargers

IMPORTANT: For the most current data, consult *MICROSEMI*'s website: http://www.microsemi.com Patent Pending

PRODUCT HIGHLIGHT



VID0	VID1	VDD > V _{BAT}	V _{BAT} > VDD		
0	0	Switch open – charging disabled.	Switch open – discharge disabled.		
0	1	Charging – USB high level if using USB.	Switch open – discharge disabled.		
1	0	Charging – USB low level if using USB.	Battery Discharging. MOSFET fully enhanced with current flow V _{BAT} to VDD.		
1	1	Charging – USB high level if using USB.	Battery Discharging. MOSFET fully enhanced with current flow V _{BAT} to VDD.		

State Select Truth Table

$T_{A}(^{\circ}C) \begin{tabular}{ll} PACKAGE ORDER INFO \\ LQ & Plastic MLP \\ 4x4mm 20-Pin \\ RoHS Compliant / Pb-free \\ -40 to 125 & LX2202CLQ \\ \end{tabular}$

Note: Available in Tape & Reel. Append the letters "TR" to the part number. (i.e. LX2202CLQ-TR)



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ABSOLUTE MAXIMUM RATINGS

Supply Voltage (VUSB or VDD)	
Analog Input Signals (VIDx, VM, SNS)	0.3V to 7V
Battery Charging Current (I _{BAT})	2A
Discharge Current (I _{VDD})	3A
Operating Junction Temperature	150°C
Storage Temperature Range	65°C to 150°C
USB Maximum DC Current	500mA
USB Maximum Surge Current	2A
RoHS / Pb-free Peak Package Solder Reflow Temperature	
(40 second maximum exposure)	260°C(+0, -5)

Note: Exceeding these ratings could cause damage to the device. All voltages are with respect to Ground. Currents are positive into, negative out of specified terminal.

THERMAL DATA

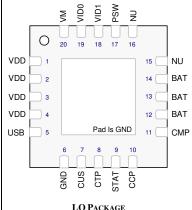
LQ Plastic Micro Lead Frame Quad Package 20-Pin THERMAL RESISTANCE-JUNCTION TO AMBIENT, θ_{JA}

40°C/W

Junction Temperature Calculation: $T_J = T_A + (P_D \times \theta_{JA})$.

The θ_{JA} numbers are guidelines for the thermal performance of the device/pc-board system. All of the above assume no ambient airflow.

PACKAGE PIN OUT



RoHS / Pb-free 100% Matte Tin Lead Finish

(Top View)

	FUNCTIONAL PIN DESCRIPTION
Name	Description
BAT	Charging Output - This pin is wired to the positive terminal of the battery. (The negative battery terminal is wired to GND.)
CCP	Charge Current Programming Pin - A resistor (RCP) is connected between this pin and GND. The constant current is determined by the following relationship: $I_{BAT(MAX)} = \frac{73200}{R_{CCP}}$
CMP	Compensation Pin – Connect a 0.1µF compensation capacitor from this pin to VDD.
СТР	Charge Termination Programming Pin – A resistor (RTP) is connected between this pin and GND. The termination charge current is determined by the following relationship: $I_{BAT(MIN)} = \frac{5250}{R_{CTP}}$
CUS	Maximum USB Current Programming Pin – A resistor (RUS) is connected between this pin and GND. The Hi Level charge current is determined by the following relationship: $I_{\text{USB(HIGH)}} = \frac{1211}{R_{\text{USB}}}$
GND	Common Ground
NU	This pin is floating and will not affect performance.
PSW	PMOS Switch driver – This output is designed to drive the gate of an external PMOS power switch. The driver is pulled low (PMOS on state) when VDD > V _{BAT} .
VDD	Common Power Node – Connects to system power bus.
VIDx	State Select Input – Applying a two bit TTL compatible signal sets the desired state of the charger corresponding to the Truth Table.
USB	Voltage Input – Current limited USB input. Apply a USB compliant power input.
VM	Voltage Mode Select - Selects the constant voltage charge level. Wired to USB for 4.1V and GND for 4.2V.
STAT	Status - This pin is a logic high level when the battery is being charged. A low signal indicates either under voltage lockout, charge completed, or V _{BAT} > VDD, or VID0 = VID1 = 0.



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ELECTRICAL CHARACTERISTICS

Unless otherwise specified, the following specifications apply over the ambient temperature $0^{\circ}\text{C} \leq T_A \leq 70^{\circ}\text{C}$ except where otherwise noted and the following test conditions: VDD = 5.0V, VM = GND, VID0 = VID1 = VBAT, RCCP = 72.3k, RCTP = 105k, RUSB = 2.55k.

Parameter	Symbol Test Conditions		LX2202			Units
	Cymbol	Took containing	Min	Тур	Max	0
MAIN CIRCUITRY				1		
Input Voltage	VDD		4.5		6	V
USB Input voltage	V _{USB}		4.35		6	V
Under Voltage Charging Lockout	VDD _{UVLO}	VBAT = 0; Rising VDD		3.60	3.85	٧
		$VDD > V_{BAT}$		2.1	4	mA
Quiescent Current	I_{GND}	$VDD < V_{BAT}$		20	40	μA
		$VDD < V_{BAT}$, $VID0 = VID1 = 0V$		9	15	μA
CTP Bias Voltage	V _{CTP}	I _{BAT} > 100mA		1.26		V
CCP Bias Voltage	V _{CCP}			1.26		V
CUS Bias Voltage	V _{CUS}			2.6		V
CONSTANT VOLTAGE MODE						
Constant Voltage Charge Voltage	V_{CVL}	VM = Lo; -40C to 125C	4.16 4.2 4.2		4.24	V
Constant Voltage Charge Voltage	▼ CVL	VM = Hi; -40 to 125C	4.06	4.1	4.14	1
Top Off Charge Droop Threshold	V_{DRP}		96	97	98	% V _{BAT} /
CONSTANT CURRENT MODE	Ditti	1	1	J		
BAT Constant Current Accuracy	I _{CCL}		0.85	1	1.15	Α
DAT CONSIGNIC CURRENT ACCURACY	ICCL ICCL		0.00		1.15	1
Conditioning Current	I _{COND}	V _{BAT} < V _{CTV} ; @25°C	3.0	4.6	6.0	% I _{BAT}
Conditioning Current Mode	V _{CTV}			2.8		V
Threshold Voltage						
Charge Termination Current Accuracy	I _{BAT}	@25°C	35	50	65	m <i>F</i>
USB CURRENT LIMIT				1		
USB Low Current Limit	I _{IN}	$V_{USB} = 5V$, $VDD < V_{USB}$, $VID1 = Lo$	85	93	100	m <i>P</i>
USB High Current Limit	I _{IN}	$V_{USB} = 5V$, $VDD < V_{USB}$, $VID1 = Hi$	425	463	500	m <i>P</i>
LOGIC						
STAT Logic High Output	V _{STAT}	$V_{USB} = 5.0V$, $I_{STAT} = -5mA$		4.5	5	V
STAT Logic Low Output	V _{STAT}	$V_{USB} = 5.0V, I_{STAT} = 25\mu A$			0.4	V
State Select Threshold	V _{VID}	Logic Hi	2.0			V
Clate Gelect Threshold	▼ VID	Logic Lo			8.0	ľ
VM Select Threshold	V_{VM}	Logic Hi	2.0			V
	▼ VM	Logic Lo			8.0	· ·
THERMAL SHUTDOWN						
Maximum Junction Temperature BI-DIRECTIONAL PASS ELEMENT	T _J CONTROL	$V_{USB} = 5.0V$, $I_{OUT} = 1A$, Temperature Rising	130	140	150	°C
Discharge Switch On Resistance	R _{DS(ON)}	I _{BAT} = -1A (Not Tested)		130	150	mΩ
Charging Threshold	V _{CHG}	V _{USB} > V _{BAT} + V _{CHG}		40		m\
Discharging Threshold	V _{DCH}	$V_{USB} < V_{BAT} + V_{DCH}$		60		m\
Pass Element Switch Mode Delay	tsw	Charge—to—discharge or Discharge—to—charge		5	10	μs
PSW FET DRIVER	1 1011	Tomargo to dicomargo of Bicomargo to orial go	_l			μο
High Output Voltage	V_{PSW}	$V_{USB} < V_{BAT}$, $I_{PSW} = 0$, $V_{BAT} = 4.2V$	4.1	4.2		V
Low Output Voltage	VPSW	$V_{USB} > V_{BAT}$, $I_{PSW} = 0$, $V_{BAT} = 4.2$	7.1	0	0.2	V
ORing Resistance	R _{PSW}	VUOD V VBAI, IPOW - U	5	10	15	KΩ
Switch Delay (after tsw)		$C_{PSW} = 1000pF$, to $V_{PSW} = (V_{BAT} - 1V)$	0	500	1000	Ns
HEAD ROOM	t _{PSW}	OPSW = TOUUPF, to VPSW = (VBAT - IV)	l U	J 500	1000	INS
HEAD KOOM		VDD VDAT I For A continue I'				
Charging headroom		VDD – VBAT, $I_{BATT} = 5mA$; not tested in production		65		m٧
Discharging boodrasm		VBAT – VDD, I _{BATT} = -20mA; not tested in		G.E.		1
Discharging headroom		production		65		m٧



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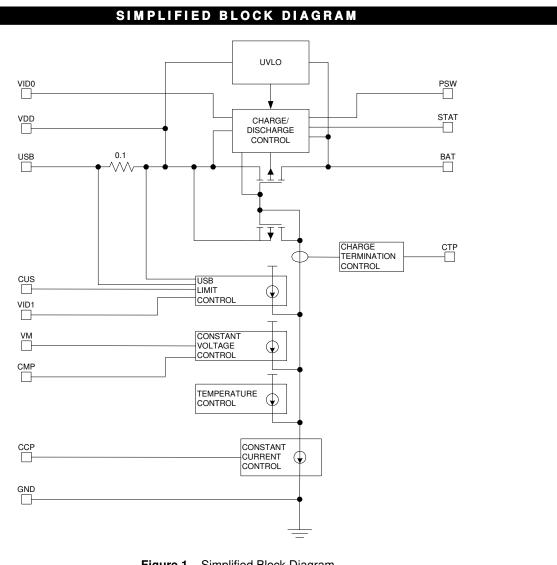


Figure 1 - Simplified Block Diagram



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APPLICATION CIRCUITS

LX2202 CONTROL FLOW DIAGRAM

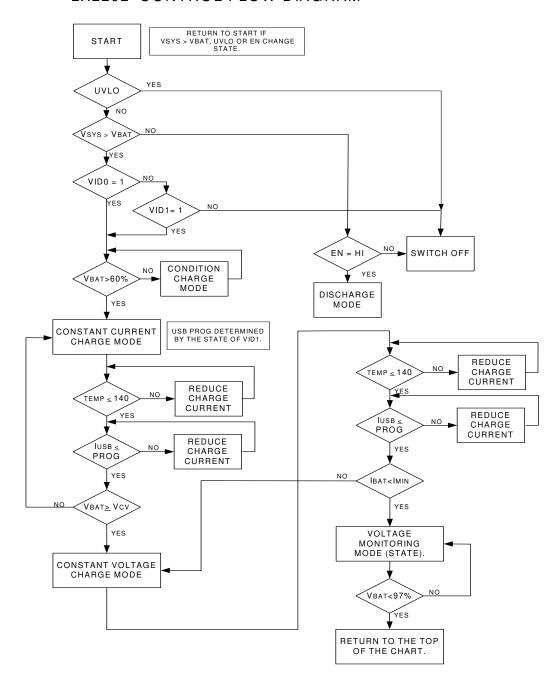
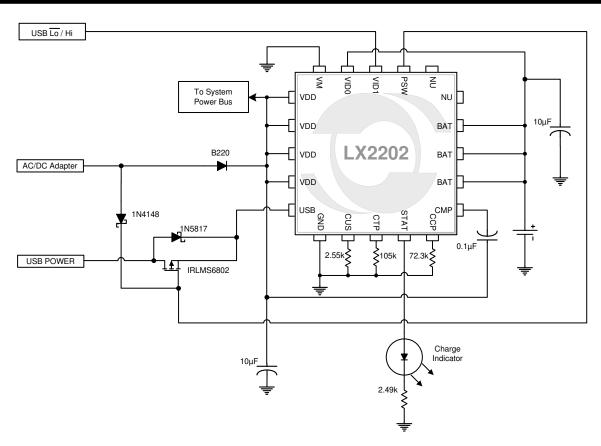


Figure 2 - Control Flow Diagram



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APPLICATION SCHEMATICS



State Select Truth Table

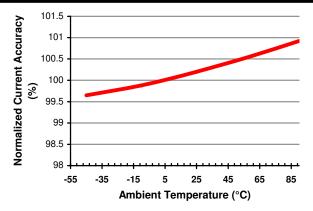
State Select Truth Table					
VID0	VID1	$VDD > V_{BAT}$	$V_{BAT} > VDD$		
0	0	Switch open – charging disabled.	Switch open – discharge disabled.		
0	1	Charging – USB high level if using USB.	Switch open – discharge disabled.		
1	0	Charging – USB low level if using USB.	Battery Discharging. MOSFET fully enhanced with current flow V _{BAT} to VDD.		
1	1	Charging – USB high level if using USB.	Battery Discharging. MOSFET fully enhanced with current flow V _{BAT} to VDD.		

Figure 3 – AC Adapter and USB Supply (Charge and Discharge Modes) (1N4148 and IRLMS6802 are optional to lower USB voltage drop.)

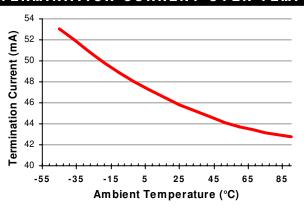


PRODUCTION DATA SHEET

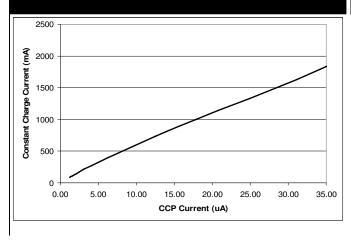
CHARGING CURRENT ACCURACY OVER TEMP



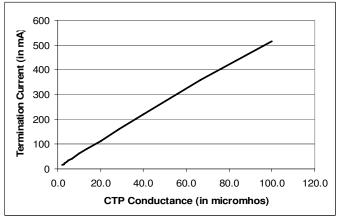
TERMINATION CURRENT OVER TEMP



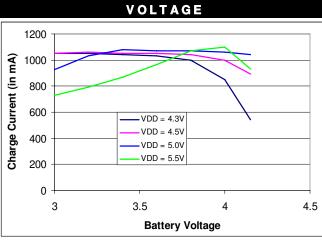
CONSTANT CURRENT PROGRAMMING



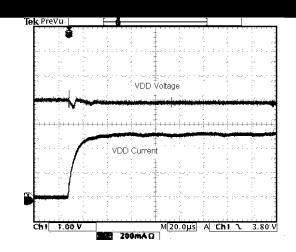
TERMINATION CURRENT VS CTP CONDUCTANCE



CHARGING CURRENT OVER VDD

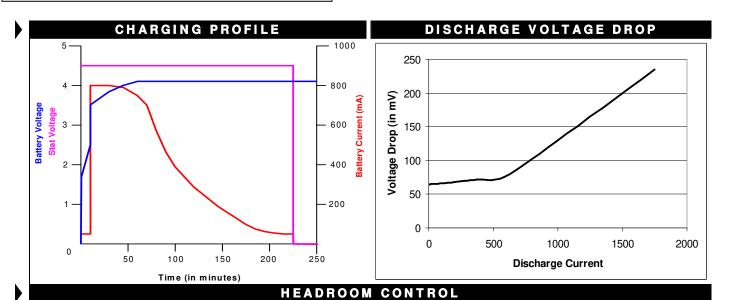


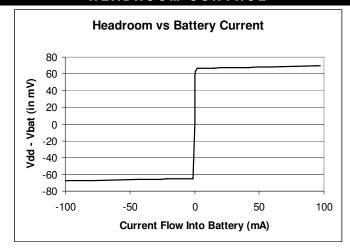
DISCHARGE MODE DYNAMIC RESPONSE





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THEORY OF OPERATION

GENERAL DESCRIPTION

The LX2202 is designed to charge a single cell Lithium Ion battery using two steps: a constant current step followed by a constant voltage step. The basic charger function uses the VDD pins as an input and BAT pins as the output. The LX2202 charger has a programmable maximum current (programmable by the resistor value between pin CCP to GND) which is the maximum charging current during the Constant Current Mode of the charging profile. The low dropout of the pass element allows the battery to be charged from a loosely regulated power supply. In the Constant Voltage Mode, the battery terminal voltage can be regulated to 4.1V or 4.2V by strapping the VM pin to VDD or GND, respectively. The charger will terminate constant voltage charging once the current drops below the minimum current setting (programmable by the resistor value between pin CTP to GND).

The LX2202 has an integrated thermostat with a linear thermal regulation loop that will throttle back the charging current to prevent the internal die temperature from exceeding 150°C. This feature prevents damage to the system board when the IC exceeds its thermal temperature.

CURRENT CHARGE MODE

A conditioning current is applied to batteries that are deeply discharged and have a terminal voltage less than 60% of the constant voltage level. The conditioning current is 5% of the CCP programmable constant current level (except where it might be limited in the USB states). Once the battery terminal voltage exceeds the 60% level, the full constant current level is applied (unless charging current is limited by one of the other charger control loops).

CHARGE TERMINATION MODE

To increase system battery life and avoid float charging, the LX2202 turns off the pass element once the battery has been fully charged. The charge termination state occurs at the end of constant voltage mode. The charge status changes state when charging is completed.

TOP OFF CHARGE MODE

Once the charger has completed a charge cycle, if power remains applied, the LX2202 enters a Voltage Monitoring mode. In this mode the LX2202 monitors the battery terminal voltage and applies a top off charge if the battery voltage drops by more than 3% of full scale. This feature is especially important for charging systems in equipment where usage is infrequent.

USB CHARGE MODE

The LX2202 is fully compliant with, and supports, the USB specifications – the Low Power Peripheral (100mA) and High Power Peripherals (500mA). VID1 logic input selects USB charge currents. The LX2202 senses the current flowing from the USB terminal to the VDD terminal; then it limits the USB current by reducing the current flowing from $V_{\rm DD}$ to $V_{\rm BAT}$.

DISCHARGE MODE

VID0 is used to enable discharge mode enable. The system load is connected to VDD. The input power is connected to VDD through an external diode. When the input power is removed, the battery current flows from V_{BAT} to VDD. The circuit of Figure 3 shows the LX2202 in a discharge mode configuration with both AC adapter and USB inputs. The USB input is diode ORed to the VDD pin and uses a MOSFET to reduce the diode drop across the ORing diode. The LX2202 provides a signal "PSW" to control the MOSFET for charge and discharge modes. When both AC and USB power are applied the PSW signal is overridden by the AC adapter diode and the MOSFET is turned off

UNDER VOLTAGE LOCK OUT

The LX2202 has an under voltage lock-out feature that monitors the VDD terminal and prevents the battery charger from entering charge mode if the VDD terminal is less than 3.6V (nominal).



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APPLICATION NOTE

REDUCED USB CHARGE TIME

The LX2202 has an isolated battery topology which reduces charge time from USB when the appliance is turned on while also charging. Because the system power rail can be a higher voltage than the battery voltage, the system will require less power from the USB source which leaves more power available to charge the battery which charges the battery faster. For example, if the system draws 1W, and the USB input is 5V, the system draws 1W/5V = 200mA from the USB source; this leaves 300mA to charge the battery. In a topology where the load connects directly to the battery (as is done with conventional linear chargers), if the average battery voltage is 3.7V, the system will draw 1W/3.7V = 270mA from the USB source, this leaves only 230mA to charge the battery. In this case the LX2202 will charge the battery 30% faster.

CURRENT LIMITED POWER SUPPLIES

The LX2202 has special headroom voltage regulation circuitry that allows charging from current limited power sources. The LX2202 increases the impedance of the pass element under small charge or discharge currents so that mode change situations can be more readily detected by the internal circuits. This improved mode discrimination allows the battery to aid the current limited input power supply when the system load demands it and to switch back to charge mode when the system power demand is reduced.

USB COMPLIANCE

To be compliant with the USB specification, the +5V current must be less than 100mA in the low power mode and less than 500mA in the high power mode. If the LX2202 is configured as shown in Figure 3, it is possible for the system to consume more than the maximum allowed USB current (in which case the battery charging current will have been fully scaled back). If it is not possible to regulate the load current when charging from a USB power source and strict adherence to the USB power budget is required, in this case the system load can be applied directly across the battery and the LX2202 will prevent the combination of the load plus battery from drawing more power than is allowed for USB compliance.

LAYOUT GUIDELINES

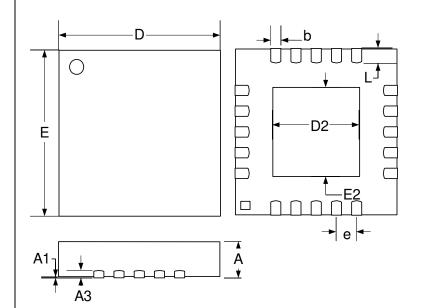
- It is important when laying out the LX2202 to place 10µF ceramic capacitors close to the VDD and V_{BAT} IC terminals to filter switching transients.
- It is important to provide a low thermal impedance path from the thermal pad on the bottom of the LX2202 package to the ground plane of the circuit board to maximize the heat dissipation.



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PACKAGE DIMENSIONS

20-Pin MLPQ Plastic 4x4mm (114x114DAP)



	M ILLIMETERS		INCHES	
Dim	MIN	MAX	MIN	MAX
Α	0.80	1.00	0.031	0.039
A1	0.00	0.05	0.000	0.002
A3	0.20 REF		0.008 REF	
b	0.18	0.30	0.007	0.088
D	4.00 BSC		0.157 BSC	
D2	2.59	2.79	0.102	0.110
E	4.00 BSC		0.157 BSC	
E2	2.59	2.79	0.102	0.110
е	0.50 BSC		0.019 BSC	
L	0.30	0.50	0.011	0.019



LX2202

2A Li-Ion Linear Charger and Power Control

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